

B12	GND
B9	VBUS
B5	CC2
A5	CC1
A9	VBUS
A12	GND
PIN	SIGNAL NAME

NOTES:

1.MATERIAL:

MOLDING: LCP UL94 V-0
 CONTACT: COPPER ALLOY.
 GOLD PLATED Min ON CONTACT AREA, 100u"
 Min TIN (LEAD FREE) ON SOLDER AREA,
 SHELL: SUS304-H,T=0.30±0.03mm
 50u" NICKEL PLATING OVER ALL.

2.MECHANICAL:

INSERTION: 5~20N.
 EXTRACTION: 8~20N AFTER TEST.
 DURABILITY: 10000 CYCLES

3.ELECTRICAL:

CURRENT: 5A FOR VBUS;
 1.25A FOR GND PIN.
 0.25A FOR OTHER.
 VOLTAGE: 20 V MAX
 WITHSTANDING VOLTAGE: 100V AC R.M.S.
 CONTACT RESISTANCE: 40mΩ MAX.
 INSULATION RESISTANCE: 100MΩ MIN.

4.ENVIRONMENTAL

TEMPERATURE RANGE -25°C ~ +85°C

5. 尺寸标注事项:

图示有标注Ⓜ者为首样全检,重点管控尺寸.

6. 产品符合RoHS标准

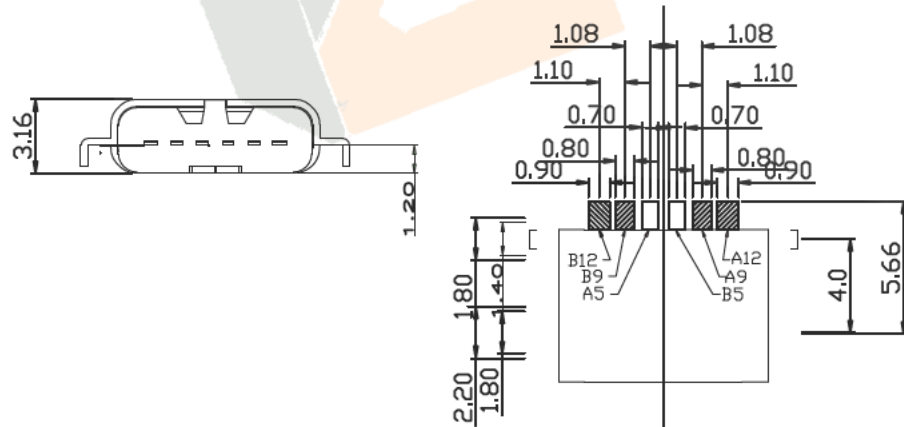
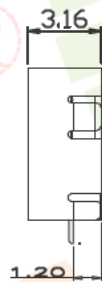
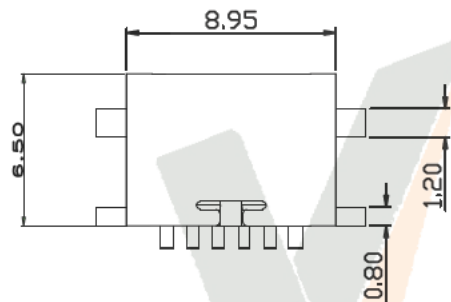
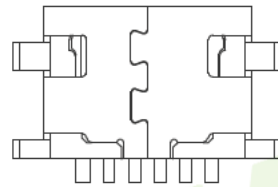
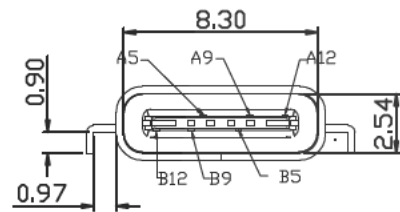
Table:

成品料号	零件名称	零件料号	材料 / 电镀
TX	端子	TX	SUS 304 R-H NO PLATING
	焊接材料	TX	SUS 301 R-H Sn 80~200u"
	外壳	TX	SUS 301 R-H 电镀铜料镀层



深圳市裕诚电子有限公司
 SHENZHEN YUCHENG ELECTRONICS CO., LTD

.X: ±0.35	.X': ±1.5'	TYPE-C-C06P-0.8	TITLE: USB TYPE C 6PIN沉板 筒易	
.XX: ±0.25	.XX': ±1.0'		www.ycelectron.com	
.XXX: ±0.20	.XXX': ±0.5'	APPD.: 陈雅	SCALE: 1:1 PAGE: 1/1	
MAT'L: SEE NOTES		CHKD.: 洪章波	UNIT: mm	REV.: AO
FINISH: 2016.2.5		DR.: 魏杰		



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B9	VBUS
B5	CC2
A5	CC1
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A12	GND
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 - TEMPERATURE RANGE -25°C ~ +85°C
- 尺寸标注事项:
 - 图示有标注者为首样全检, 重点管控尺寸.
- 产品符合RoHS标准

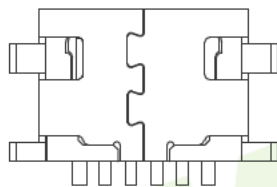
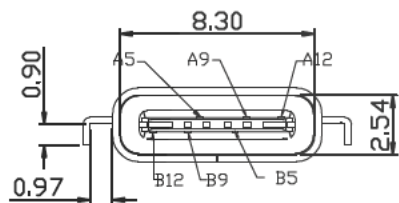
Table:

成品料号	零件名称	零件料号	材料 / 电镀
TX	端子	TX	SUS 304 R-H NO PLATING
	塑胶材料	TX	SUS 301 R-H Sn 80~200u"
	外壳	TX	SUS 301 R-H 电镀镍铬合金



深圳市裕诚电子有限公司
SHENZHEN YUCHENG ELECTRONICS CO., LTD

.X: ±0.35	.X': ±1.5'	TYPE-C-C06P-1.2	TITLE: USB TYPE C 6PIN沉板 简易版	
.XX: ±0.25	.XX': ±1.0'		www.ycelectron.com	
.XXX: ±0.20	.XXX': ±0.5'	APPD.: 陈雅	SCALE: 1:1 PAGE: 1/1	
MAT'L.: SEE NOTES		CHKD.: 洪章波	UNIT: mm	REV.: A0
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图示有标注的“*”者为首件全检,重点管控尺寸.

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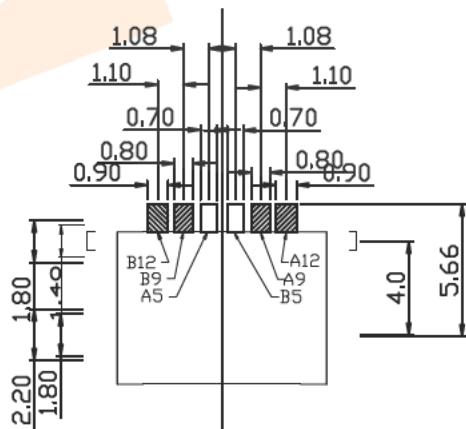
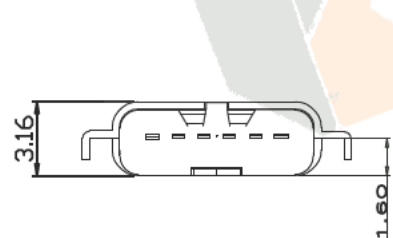
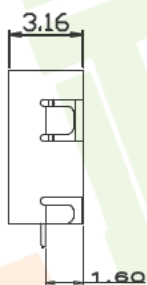
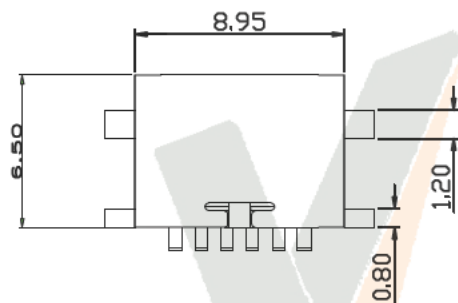


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	外壳	TX	SUS 301 R-H 电镀镍料带底



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